

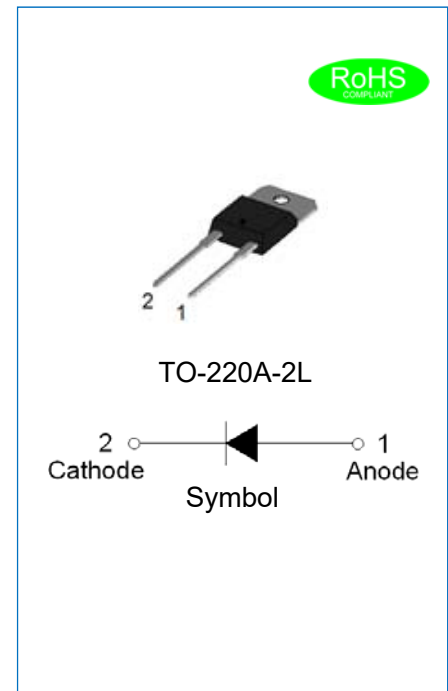


JECR3006AL EPI HYPERFAST SOFT RECOVERY RECTIFIER

Rev.1.4

DESCRIPTION

- ✧ Plastic package has underwriters laboratory flammability classification 94V-0
- ✧ Lead free in comply with EU RoHS 2011/65/EU directives
- ✧ Low reverse leakage current
- ✧ Hyperfast recovery time and soft recovery characteristics
- ✧ Low recovery loss
- ✧ Applications for discontinuous current mode (DCM) power factor correction (PFC), active PFC in air conditioner, high frequency switched-mode power supplies
- ✧ Insulation (2500V_{RMS}) allows placement on same heatsink as mosfet and flexible heatsinking on common or separate heatsink



MECHANICAL DATA

- ✧ Case: TO-220A-2L molded plastic over passivated junction
- ✧ Terminals: Solder plated, solderable per J-STD-002
- ✧ Internally constructed isolated package is offered for ease of heat sinking with highest isolation voltage
- ✧ Weight: 2.1 gram

ABSOLUTE MAXIMUM RATING (Rating at 25°C ambient temperature unless otherwise specified.)

Parameter	Symbol	JECR3006AL	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	600	V
Maximum DC blocking voltage	V_{DC}	600	V
Average forward current at $T_{mb}=90^{\circ}\text{C}$	$I_{F(AV)}$	30	A
Peak forward surge current: 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	220	A
Peak forward surge current: 10ms single half sine-wave superimposed on rated load		200	
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150	$^{\circ}\text{C}$

ISOLATION CHARACTERISTICS

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{isol(RMS)}$	RMS isolation voltage	50Hz≤f≤60Hz, RH≤65%, from all pins to external heatsink, sinusoidal waveform, clean and dust free	-	-	2500	V
C_{isol}	Isolation capacitance	from cathode to external heatsink	-	10	-	pF

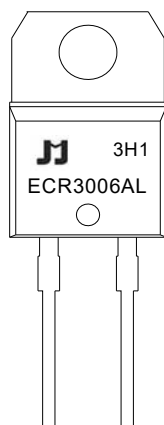
ELECTRICAL CHARACTERISTICS (Rating at 25°C ambient temperature unless otherwise specified.)

Parameter		Symbol	Min.	Typ.	Max.	Unit
Forward voltage	$I_F=30A, T_J=25^{\circ}C$	V_F	-	2	2.75	V
	$I_F=30A, T_J=150^{\circ}C$		-	1.38	1.8	
Reverse current	$V_R=600V, T_J=25^{\circ}C$	I_R	-	-	5	μA
	$V_R=600V, T_J=150^{\circ}C$		-	-	400	
Reverse recovery time	$I_F=1A, V_R=30V, di/dt=50A/\mu s, T_J=25^{\circ}C$	t_{rr}	-	-	35	ns
	$I_F=30A, V_R=200V, di/dt=200A/\mu s, T_J=25^{\circ}C$		-	35	-	
	$I_F=30A, V_R=200V, di/dt=200A/\mu s, T_J=125^{\circ}C$		-	70	-	
Peak reverse recovery current	$I_F=30A, V_R=200V, di/dt=200A/\mu s, T_J=25^{\circ}C$	I_{RM}	-	3.5	-	A
	$I_F=30A, V_R=200V, di/dt=200A/\mu s, T_J=125^{\circ}C$		-	7.6	-	
Recovered charge	$I_F=30A, V_R=200V, di/dt=200A/\mu s, T_J=25^{\circ}C$	Q_r	-	50	-	nC
	$I_F=30A, V_R=200V, di/dt=200A/\mu s, T_J=125^{\circ}C$		-	280	-	

THERMAL RESISTANCES

Symbol	Parameter	Min.	Typ.	Max.	Unit
$R_{th(j-mb)}$	Thermal resistance from junction to mounting base	-	-	2.1	$^{\circ}C/W$
$R_{th(j-a)}$	Thermal resistance from junction to ambient	-	60	-	$^{\circ}C/W$

MARKING



ECR	EPI Hyperfast Recovery Rectifier
30	$I_{F(AV)}=30A$
06	$V_{RRM}:600V$
AL	Package: TO-220A-2L

$\underline{x}H1$: Month, 1/2/3~9/A/B/C

$3\underline{x}1$:

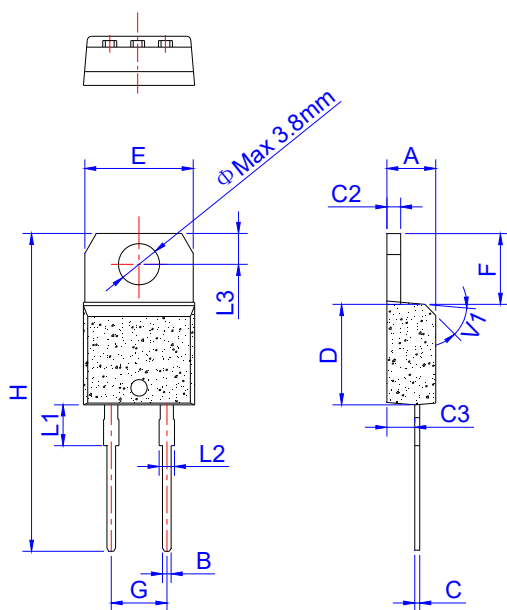
2018	2019	2020	2021	2022	2023	2024
H	I	J	K	L	M	N
2025	2026	2027	2028	2029	2030	...
O	P	Q	R	S	T	...

$3H\underline{x}$: Batch number

ORDERING INFORMATION

J	E	C	R	30	06	AL
JieJie Microelectronics	Epi Hyperfast	Rectifier		$I_{F(AV)}=30A$	$V_{RRM}:600V$	Package:TO-220A-2L

PACKAGE MECHANICAL DATA



TO-220A-2L Ins

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.61		0.88	0.024		0.035
C	0.46		0.70	0.018		0.028
C2	1.21		1.32	0.048		0.052
C3	2.40		2.72	0.094		0.107
D	8.60		9.70	0.339		0.382
E	9.80		10.4	0.386		0.409
F	6.55		6.95	0.258		0.274
G		5.08			0.1	
H	28.0		29.8	1.102		1.173
L1		3.75			0.148	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
V1		45°			45°	

PACKAGE INFORMATION- TO-220A-2L

OUTLINE	UNIT WEIGHT (g/PCS) TYP	TUBE (PCS)	PER CARTON (PCS)
TUBE	2.1	50	5,000

CHARACTERISTICS CURVE

FIG.1: Typical forward characteristics

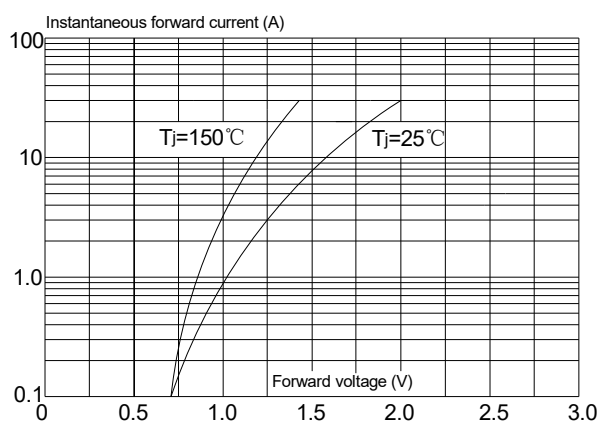


FIG.2: Typical reverse characteristics

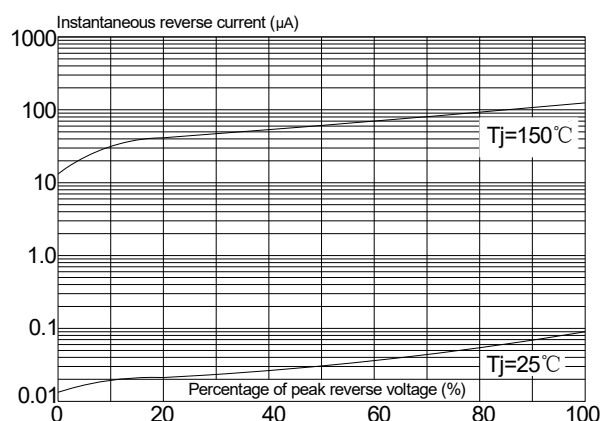


FIG.3: Maximum non-repetitive peak forward surge current(10ms single half sine-wave)

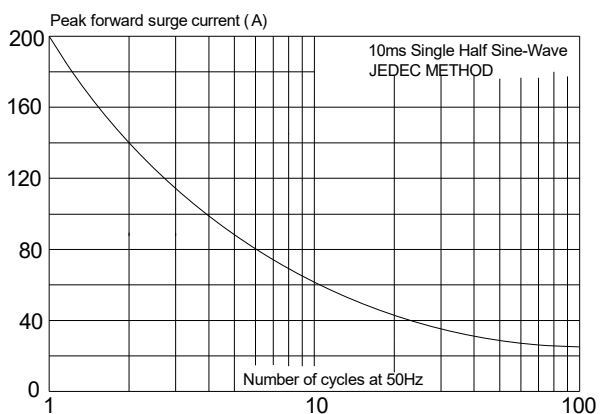


FIG.4: Maximum non-repetitive peak forward surge current(8.3ms single half sine-wave)

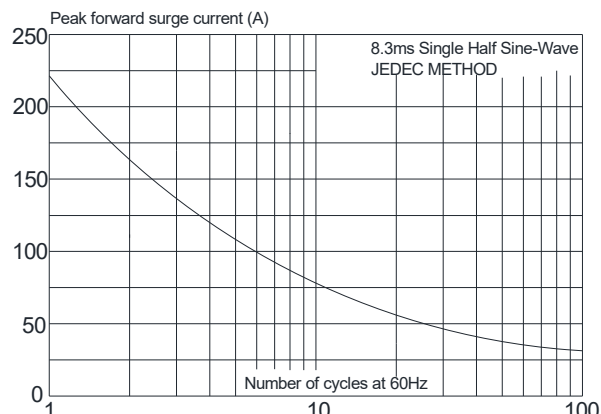


FIG.5: Forward current derating curve

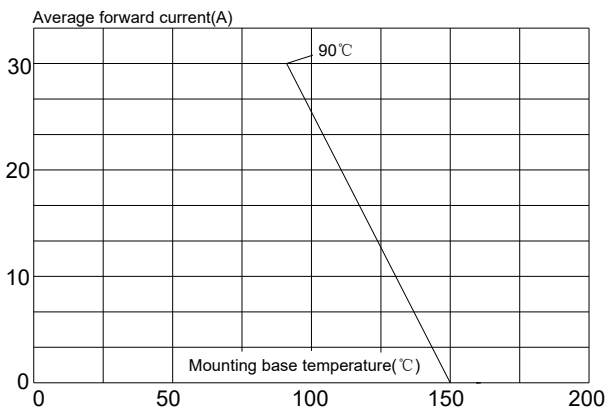
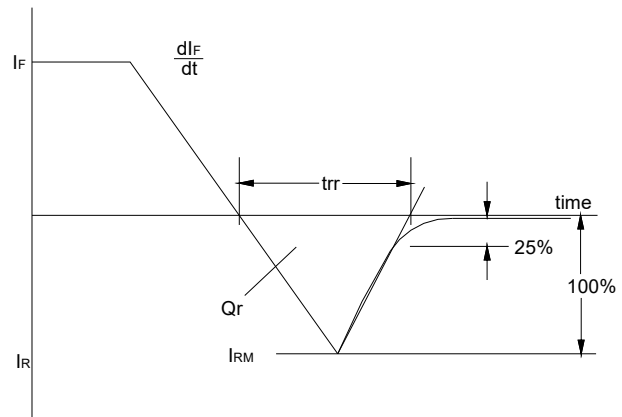


FIG.6: Reverse recovery definitions



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